

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :  
Morio GAKU et al. :  
Serial No. NEW : **Attn: APPLICATION BRANCH**  
Filed March 31, 2004 : Attorney Docket No. 2004\_0517

METHOD OF MAKING THROUGH HOLE  
WITH LASER, COPPER-CLAD LAMINATE  
SUITABLE FOR MAKING HOLE, AND  
AUXILIARY MATERIAL FOR MAKING  
HOLE

**(Rule 1.53(b) Divisional  
of Serial No. 10/028,734,  
Filed December 28, 2001)**

**CLAIM OF PRIORITY UNDER 35 USC 119**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application Nos. 10-068357, filed March 18, 1998; 10-140472, filed May 7, 1998; 10-145206, filed May 12, 1998; 10-145205, filed May 12, 1998; 10-250447, filed August 20, 1998; 10-216411, filed July 15, 1998; 10-166324, filed May 29, 1998; 10-167759, filed June 1, 1998; and 10-167760, filed June 1, 1998, as acknowledged in the Declaration of this application.

Certified copies of said Japanese Patent Applications are of record in parent application Serial No. 09/271,897, filed March 18, 1999.

Respectfully submitted,

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